

L Number	Hits	Search Text	DB	Time stamp
1	1	(segmentation and packag\$3 and integrated adj circuit).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 12:00
2	168	(segment\$6 and packag\$3 and integrated adj circuit).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 12:14
3	81	((segment\$6 and packag\$3 and integrated adj circuit).ab.) and @ad<19990119	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 12:15
4	417	(segment\$6 and electronic and structure).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 12:14
5	248	((segment\$6 and electronic and structure).ab.) and @ad<19990119	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 13:46
6	9	((segment\$6 and electronic and structure).ab.) and @ad<19990119) and segmentation	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 13:44
7	0	(model and electronic adj structure same segment\$4).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 13:45
8	0	(model and electronic adj structure and segment\$4).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 13:46
9	32	(model and package and segment\$4).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 13:46
10	5	((model and package and segment\$4).clm.) and @ad<19990119	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:02
11	49	segmentation same integrated adj circuit and package	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 14:54
12	25	(segmentation same integrated adj circuit and package) and @ad<19990119	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 14:59

15	302	257/\$.ccls. and segmentation	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:06
16	166	(257/\$.ccls. and segmentation) and @ad<19990119	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:02
17	3	((257/\$.ccls. and segmentation) and @ad<19990119) and (analy\$3 same package)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:05
18	0	364/\$.ccls. and segmentation	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:06